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REVISIONS

<u>DISTRIBUTION STATEMENT A</u>. Approved for public release; distribution is unlimited.

1. SCOPE ***********************************						
1.2 Part or Identifying Number (PIN). The complete PIN shall be as shown in the following example: Sy62-87794	1. SCOPE	***	***			
Drawing number Device type (See 1.2.1) 1.2.1 Device type (See 1.2.2) Device type (See 1.2.2)	MI 2510-888 2 Provisions for the distriction	device requirements f of MIL-STD-883 in conj	or class B mi unction with	crocircuits i compliant nor	in accordance with 1. n-JAN devices".	.2.1 of
Drawing number Device type (See 1.2.1) Device type(S). The device type(S) shall identify the circuit function as follows: Device type Generic number Circuit function O1 54AS805 Hex 2-input NOR drivers 1.2.2 Case outline(S). The case outline(S) shall be as designated in appendix C of MIL-M-38510, and as follows: Outline letter R D-8 (20-lead, 1.060" x .310" x .200"), dual in line package S F-9 (20-lead, .540" x .300" x .100"), flat package C-2 (20-terminal, .358" x .358" x .100"), square chip carrier package 1.3 Absolute maximum ratings. Supply voltage range	1.2 Part or Identifying Number (PIN	<u>I)</u> . The complete PIN	shall be as s	shown in the f	following example:	
(See 1.2.1) (See 1.2.2) MIL-M-38510 1.2.1 Device type(s). The device type(s) shall identify the circuit function as follows: Device type Generic number O1 54AS805 Hex 2-input NOR drivers 1.2.2 Case outline(s). The case outline(s) shall be as designated in appendix C of MIL-M-38510, and as follows: Outline letter R D-8 (20-lead, 1.060" x .310" x .200"), dual in line package S F-9 (20-lead, .540" x .300" x .100"), flat package C-2 (20-terminal, .358" x .358" x .100"), square chip carrier package 1.3 Absolute maximum ratings. Supply voltage range	<u>5962-87794</u>	<u>01</u>		R	<u> </u>	
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R D-8 (20-lead, 1.060" x .310" x .200"), dual in line package S F-9 (20-lead, .540" x .300" x .100"), flat package C-2 (20-terminal, .358" x .358" x .100"), square chip carrier package Supply voltage range		acemets, share be as		п арренати о	o,	
S F-9 (20-lead, .540" x .300" x .100"), flat package 1.3 Absolute maximum ratings. Supply voltage range		N 9 (20 Land 1 0		2008) dual	in litto packago	
Supply voltage range	s	F-9 (20-lead, .54	0" x .300" x .	.100"), flat j	package	
Supply voltage range	2	C-2 (20-terminal,	.358" x .358	" x .100"), s	quare chip carrier p	ackage
Input voltage range $-$	1.3 Absolute maximum ratings.					
Storage temperature range $$	Supply voltage range					
Thermal resistance, junction-to-case (θ_{JC}): Cases R, S, and 2	Storage temperature range			-65°C to +150		
Thermal resistance, junction-to-case (θ_{JC}): Cases R, S, and 2	maximum power dissipation (P _D) Lead temperature (soldering, 10	per device <u>1</u> /) seconds)				
Junction temperature (T _J)+175°C 1.4 <u>Recommended operating conditions</u> .	Thermal resistance, junction-to Cases R. S. and 2	-case (θ _{JC}): 		See MIL-M-38	510, appendix C	
	Junction temperature (T _J)			+175°C		
Supply voltage range (V _{CC}) +4.5 V minimum to +5.5 V maximum. Minimum high level input voltage (V _{IL}) 2.0 V Maximum low level input voltage (V _{IL}) 0.8 V Case operating temperature range (↑ _C)						
Maximum low level input voltage (V _{IL}) 0.8 V Case operating temperature range († _C)	Supply voltage range (V _{CC})		. .	+4.5 V minimu	um to +5.5 V maximum	
case operating temperature range (1 _C)	Maximum low level input voltage	(A ^{Ir})		0.8 V	:00	
	tase operating temperature rang	le (1 ^C)		-55°C TO +125) · L	

1/	Must	withstand	the	added	P.	due	to	short	circuit	test	(e.q.,	Inc)	

STANDARDIZED MILITARY DRAWING	SIZE A		5962-87794
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 2

2. APPLICABLE DOCUMENTS

首用 5 Government specification retained, and bulletin. Unless otherwise specified, the following specification, standard, and bulletin of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

- Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883

- Test Methods and Procedures for Microelectronics.

BULLETIN

MILITARY

MIL-BUL-103

- List of Standardized Military Drawings (SMD's).

(Copies of the specification, standard, and bulletin required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

REQUIREMENTS

- 3.1 <u>Item requirements</u>. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
 - 3.2.1 <u>Case outline(s)</u>. The case outline(s) shall be in accordance with 1.2.2 herein.
 - 3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.
 - 3.2.3 <u>Truth table</u>. The truth table shall be as specified on figure 2.
 - 3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.
 - 3.2.5 <u>Test circuit and waveforms</u>. The test circuit and waveforms shall be as specified on figure 4.
- 3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full case operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.
- 3.5 <u>Marking</u>. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-BUL-103 (see 6.6 herein).
- 3.6 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.6 herein). The certificate of compliance submitted to DESC-ECC prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-87794
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL A	SHEET 3

DESC FORM 193A

JUL 91

TABLE I. Electrical performance characteristics.

<u> 查询"5962-87794012/</u>	" 供应	Condition	ons 1/2/	Group A	Lin	its	Unit
rest	Зуньос	-55°C < 1	c.≤ +125°c	subgroups	Min	Max	
		unless other	wise specified				
High level output voltage	v _{он}	V _{CC} = 4.5 V	I _{OH} = -2.0 mA		2.5		V
		$v_{CC} = 4.5 \text{ V}$ $v_{IL} = 0.8 \text{ V}$ $v_{IH} = 2.0 \text{ V}$	$I_{OH} = -3.0 \text{ mA}$	1,2,3	2.4		
			$I_{OH} = -40.0 \text{ mA}$	<u> </u>	2.0		
Low level output voltage	v _{oL}	V _{CC} = 4.5 V V _{IL} = 0.8 V V _{IH} = 2.0 V	$I_{OL} = 40 \text{ mA}$	1,2,3		0.5	V
Input clamp voltage	A ^{IC}	V _{CC} = 4.5 V	I _{IN} = -18 mA	1,2,3		-1.2	V
Low level input current	IIL	V _{CC} = 5.5 V V _{II} = 0.4 V All other inpu	ts = 4.5 V	1,2,3		-0.5	mA
High level input current	I IH1	V _{CC} = 5.5 V V _{IH} = 2.7 V	All other	1,2,3	 	20	μA
	I _{IH2}	V _{CC} = 5.5 V V _{IH} = 7.0 V	inputs = 0.0 V	1,2,3		0.1	mA
Output current	I _O	V _{CC} = 5.5 V V _{OUT} = 2.25 V	<u>4</u> /	1,2,3	 -50 	-200	mA
Supply current	Іссн	V _{CC} = 5.5 V V _{IN} = 0.0 V		1,2,3		10	 mA
	I _{CCL}	V _{CC} = 5.5 V V _{IN} = 4.5 V				32	
Functional tests		V _{CC} = 4.5 V ar see 4.3.1c		7,8			
Propagation delay time A or B to Y	t _{PLH}	$V_{CC} = 4.5 \text{ V ar}$ $C_{L} = 50 \text{ pF } \pm 10$ $R_{L} = 500\Omega \pm 5\%$	nd 5.5 V 0%	9,10,11	1	4.8	ns
	t _{PHL}	See figure 4	<u>5</u> /	9,10,11	1	4.8	ns

- 1/ Unused inputs that do not directly control the pin under test must be put at \geq 2.5 V or \leq 0.4 V.
- $\underline{2}$ / Unused inputs shall not exceed 5.5 V or go less than 0.0 V. No inputs shall be floated.
- $\underline{3}/$ All outputs must be tested. In the case where only one input at V $_{IL}$ maximum or V $_{IH}$ minimum produces the proper output state, the test must be performed with each input being selected as the V $_{IL}$ maximum or V $_{IH}$ minimum input.
- 4/ The output conditions have been chosen to produce a current that closely approximates one-half of the true short circuit output current, I_{OS}. Not more than one output should be tested at a time and the duration of the test should not exceed one second.
- 5/ Propagation delay limits are based on single output switching. Unused outputs = 3.5 V or ≤ 0.3 V.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-87794
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 4

查询"5962-87794012A"供应商

Device type	01					
Case outlines	R and S	2				
 Terminal number	Terminal symbol					
1	1A	1A				
2	1в	18				
3	1Y	1Y				
4	2A	2A				
5	2в	2В				
6	2Y	2Y				
7	3A	3A				
8	3B	3B				
9	3Y	3Y				
10	GND	GND				
11	4Y	4Y				
12	4A	4A				
13	4B	4B				
14	5Y	5Y				
15	5A	5A				
16	5B	5B				
17	6Y	6Y				
18	6A	6A				
19	6В	6B				
20	v _{cc}	v _{cc}				

FIGURE 1. <u>Terminal connections</u>.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-87794
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 5

查询"5962-87794012A"供应商

Inp	uts	Output
A	В	Y
н	X	L
X	н	L
L	L	н

H = High level voltage L = Low level voltage

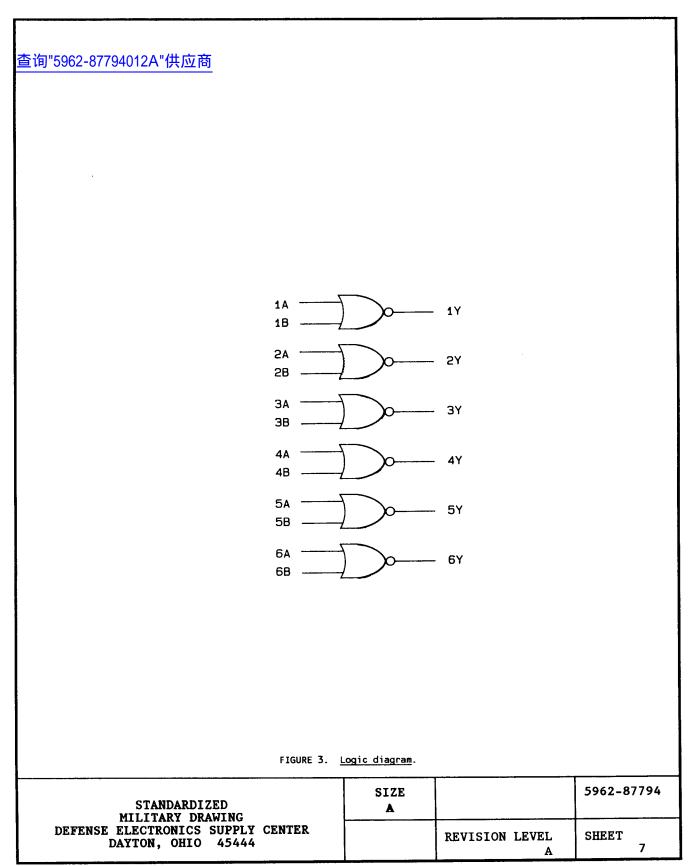
X = Irrelevant

FIGURE 2. Truth table.

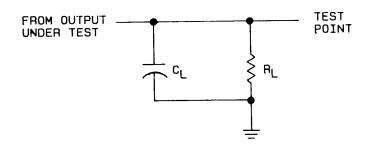
5962-87794 SIZE STANDARDIZED
MILITARY DRAWING
DEFENSE ELECTRONICS SUPPLY CENTER A REVISION LEVEL SHEET DAYTON, OHIO 45444 6

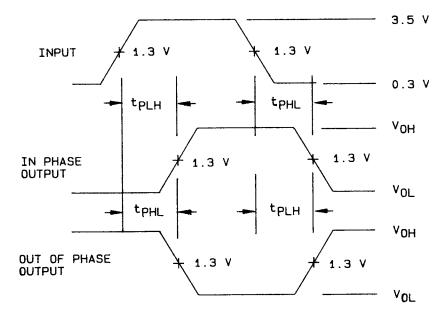
DESC FORM 193A

JUL 91



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NOTES:

- C₁ includes probe and jig capacitance.
 Att input pulses have the following characteristics: PRR ≤ 10 MHz, t_r = t_f = 3 ns ±1 ns, duty cycle = 50 percent.

 3. The outputs are measured one at a time with one input transition per measurement.

FIGURE 4. Test circuit and waveforms.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-87794
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 8

- 3.7 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 查询"5962-87794012A"供应商 3.8 <u>Notification of change</u> Notification of change to DESC-ECC shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.9 <u>Verification and review</u>. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
 - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 <u>Screening</u>. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
 - (2) $T_A = +125^{\circ}C$, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection.
 - a. Tests shall be as specified in table II herein.
 - b. Subgroups 4, 5, and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
 - c. Subgroup 7 shall include verification of the truth table.
 - 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
 - (2) $T_A = +125$ °C, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-87794
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 9

TABLE II. Electrical test requirements.

Interim electrical parameters (method 5004)	
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Final electrical test parameters (method 5004)	1*, 2, 3, 7, 8, 9, 10, 11
Group A test requirements (method 5005)	1, 2, 3, 7, 8, 9, 10, 11
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

^{*} PDA applies to subgroup 1.

- 5. PACKAGING
- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.
- 6. NOTES
- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).
- 6.4 <u>Record of users</u>. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and the applicable SMD. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DESC-ECC, telephone (513) 296-6022.
- 6.5 <u>Comments</u>. Comments on this drawing should be directed to DESC-ECC, Dayton, Ohio 45444, or telephone (513) 296-8525.
- 6.6 <u>Approved sources of supply</u>. Approved sources of supply are listed in MIL-BUL-103. The vendors listed in MIL-BUL-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-ECC.

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A		5962-87794
		REVISION LEVEL	SHEET 10

DESC FORM 193A

JUL 91

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